

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	39283	crosstalk	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/28 10:03
L2	152	inductance adj matrix	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/28 10:03
L3	182	capacitance adj matrix	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/28 10:04
L4	264968	diagonal\$2	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/28 10:04
L5	1072	self-inductance and (mutual adj inductance)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/28 10:05
L6	7405	total adj capacitance	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/28 10:06
L7	17	2 and 4 and 5	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/28 10:06
L8	6	3 and 4 and 6	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/28 10:06

L9	2	7 and 8	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/28 10:06
L10	0	1 and 9	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/28 10:09
L11	1	1 and 8	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/28 10:07
L12	1	1 and 7	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/28 10:08
L13	81976	wir\$3 near bond\$3	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/28 10:10
L14	597695	package	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/28 10:10
L15	32575	13 and 14	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/28 10:10
L16	530	crosstalk near5 (high adj frequency)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/28 10:11

L17	0	15 and 11	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/28 10:11
L18	0	15 and 12	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/28 10:11
L19	0	16 and 12	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/28 10:11
L20	0	16 and 11	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/28 10:12
L21	998	15 and 1	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/28 10:12
L22	1	21 and 2 and 3	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/28 10:14
L23	1373	(716/5).ccs.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/28 10:15

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	0	((crosstalk or noise) and bond\$3 and wir\$3 and equivalent and resistance and capacitance and inductance and (inductance adj matrix) and (capacitance adj matrix) and diagonal\$2 and self-inductance and mutual\$2).clm.	US-PGPUB; USPAT	OR	ON	2005/07/28 10:18



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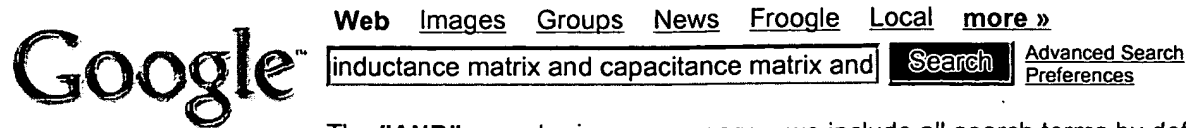
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